

## POWERED BY Dialog

**Polyolefinic resin composition, useful for shaping general purpose objects, comprises olefinic resin, thermoelastomer and diester compound**

**Patent Assignee: DAIKYO KK**

**Patent Family**

Patent Number	Kind	Date	Application Number	Kind	Date	Week	Type
JP 2001279031	A	20011010	JP 2000134013	A	20000330	200217	B

**Priority Applications (Number Kind Date):** JP 2000134013 A ( 20000330)

**Patent Details**

Patent	Kind	Language	Page	Main IPC	Filing Notes
JP 2001279031	A		6	C08L-023/00	

**Abstract:**

JP 2001279031 A

NOVELTY A polyolefinic resin composition contains olefinic resin, thermoelastomer and diester compound. The compositions flexibility is controllable.

DETAILED DESCRIPTION A polyolefinic resin composition contains:

- (1) 100 pts. wt. of olefinic resin with melting temperature or softening temperature of up to 150degreesC,
- (2) 15-100 pts. wt. of thermoelastomer, and
- (3) 1-30 weight parts of ester compound of formula  $R(EO)_nO(O)CXC(O)O(EO)_mR(I)$ .

X=2-12 C alkylene, aromatic or alicyclic dibasic acid residue;

R=optionally same or different each other 1-15 C alkyl;

E=2-4 C alkylene;

m=1-7;

n=0-7.

USE The composition is useful for all purpose applications.